

06-13-2007



103415912

First Named Inventor

Hoi Tak Raymond Lam

Title

Fan Heater and Shoe Dryer

Attorney Docket Number

KYLO/112DES/US

Date

June 4, 2007

Mail Stop Assignment Recordation Services Director of the United States Patent and
Trademark Office, P.O. Box 1450, Alexandria, Virginia 22313-1450

Please record the attached document.

1. Name of conveying party(ies):

Hoi Tak Raymond Lam

2. Name and address of receiving party(ies):

Name: South Asia International (HK) Limited
Street Address: Unit 1101-1104, Peninsula Square
18 Sung On Street, Hunghom
City, State, ZIP: Kowloon, Hong Kong
Country: China

Country of Incorporation: Hong Kong

3. Nature of Conveyance: Assignment

Execution Date: May 29, 2007

4. This document is being filed with a new application,
-
- the execution date of which is: May 29, 2007

5. Name and address of party to whom correspondence document should be mailed:

Guy D. Yale, Esq.
Alix, Yale & Ristas, LLP
750 Main Street, Suite 1400
Hartford, CT 06103-2721

6. Total number of applications involved: 1

7. Total fee enclosed: \$40.00. If this amount is incorrect, please charge or credit the
-
- difference to Deposit Account No. 16-2563.

8. Total number of pages including cover sheet, attachments and documents: 3

To the best of my knowledge and belief, the foregoing information is true and correct.

SIGNATURE OF APPLICANT, ATTORNEY OR AGENTFirm or
Individual name

Guy D. Yale

Reg. No.

29,125

Signature

Date

June 4, 2007

Attorney's Docket No.

KYLO/112DES/US

EV196537480US

PATENT
REEL: 019436 FRAME: 0280

ASSIGNMENT

WHEREAS, I, Hoi Tak Raymond Lam, residing at Unit 1101-1104, 11/F, Peninsula Square, 18 Sung On Street, Hunghom, Kowloon, Hong Kong, China, have invented new and useful improvements in

Fan Heater and Shoe Dryer

for which I am making application for Letters Patent of the United States, which application was executed by me on the _____ day of _____ 2007; and

WHEREAS, South Asia International (HK) Limited, a Hong Kong corporation, having a place of business at Unit 1101-1104, Peninsula Square, 18 Sung On Street, Hunghom, Kowloon, Hong Kong, China, is desirous of acquiring the entire right, title and interest in and to said improvements and any Letters Patent which may be granted thereon;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$1.00) to me in hand paid and other good and valuable consideration, receipt of which is hereby acknowledged, I, the said Hoi Tak Raymond Lam, sell, assign and transfer to South Asia International (HK) Ltd, its successors and assigns (hereinafter called "Assignee"), the entire right, title and interest in and to said improvements and in and to any Letters Patent which may be obtained thereon in the United States, together with said application and all divisional, continuing, substitute, renewal, reissue, and other applications for Letters Patent which have been or may be filed on said improvements in the United States, the same to be held and enjoyed by the Assignee for its and their sole use and behoof.

I hereby authorize and request the Commissioner of Patents and Trademarks to issue all Letters Patent of the United States on said improvements to the Assignee.

I further covenant and agree that when requested by the Assignee, and without further consideration, but at the cost and expense of the Assignee, I will execute and deliver all applications for patent on said improvements, execute all lawful oaths and other papers, supply to the Assignee all facts and evidence known to me relating to said improvements and the history and development thereof, testify in all interferences, suits, and other legal proceedings, and generally do everything rightful which the Assignee shall consider desirable for aiding in securing, maintaining, and enforcing proper patent protection for said improvements and for vesting the title to said improvements in the Assignee.

I further covenant that I have the lawful right to assign the interest in said improvements in the manner and form as herein expressed, that the interests herein conveyed are free from prior assignment, grant, mortgage, license, or other encumbrance whatsoever and that the execution of this Assignment is my own free act and deed.

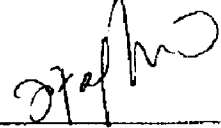
Date: 29TH MAY 2007



Hoi Tak Raymond Lam



Witness LEE PUI YI



Witness CHAN FU LAI